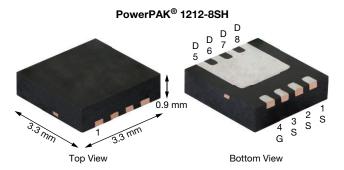
## SiSH108DN

www.vishay.com

**Vishay Siliconix** 

COMPLIANT

# N-Channel 20 V (D-S) Fast Switching MOSFET



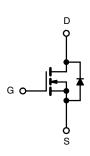
PRODUCT SUMMARY	
V <sub>DS</sub> (V)	20
$R_{DS(on)}$ max. ( $\Omega$ ) at $V_{GS}$ = 10 V	0.0049
$R_{DS(on)}$ max. ( $\Omega$ ) at $V_{GS}$ = 4.5 V	0.0061
Q <sub>g</sub> typ. (nC)	20
I <sub>D</sub> (A)	22
Configuration	Single

#### **FEATURES**

- TrenchFET<sup>®</sup> Gen II power MOSFET for ultra low on-resistance
  RoHS
- 100 % R<sub>a</sub> tested
- Material categorization: for definitions of **FREE** compliance please see <u>www.vishay.com/doc?99912</u>

#### **APPLICATIONS**

- Synchronous rectification
- Point-of-load converters
- Protection devices
- Hot swap



N-Channel MOSFET

ORDERING INFORMATION	
Package	PowerPAK 1212-8
Lead (Pb)-free and halogen-free	SiSH108DN-T1-GE3

ABSOLUTE MAXIMUM RATINGS	(T <sub>A</sub> = 25 °C, un	less otherwise	noted)		
PARAMETER		SYMBOL	10 s	STEADY STATE	UNIT
Drain-source voltage		V <sub>DS</sub>	20	20	V
Gate-source voltage		V <sub>GS</sub>	± 16	± 16	
Continuous drain current (T <sub>J</sub> = 150 °C) <sup>a</sup>	T <sub>A</sub> = 25 °C	1	22	14	
	T <sub>A</sub> = 70 °C	I <sub>D</sub>	17.6	11.2	
Pulsed drain current		I <sub>DM</sub>	60	60	A
Continuous source current (diode conduction) <sup>a</sup>		I <sub>S</sub>	3.2	1.3	
Single avalanche current	L = 0.1 mH	I <sub>AS</sub>	22	22	
Single avalanche energy		E <sub>AS</sub>	24	24	mJ
Maximum power dissipation <sup>a</sup>	T <sub>A</sub> = 25 °C	PD	3.8	1.5	W
	T <sub>A</sub> = 70 °C		2.0	0.8	vv
Operating junction and storage temperature range		T <sub>J</sub> , T <sub>stg</sub>	-55 to +150		0°
Soldering recommendations (peak temperature) b, c			2	60	-0

THERMAL RESISTANCE RATINGS					
PARAMETER		SYMBOL	TYPICAL	MAXIMUM	UNIT
Maximum junction to ambient a	t ≤ 10 s	Р	24	33	
Maximum junction-to-ambient <sup>a</sup>	Steady state	R <sub>thJA</sub>	65	81	°C/W
Maximum junction-to-case (drain)	Steady state	R <sub>thJC</sub>	1.9	2.4	

#### Notes

a. Surface mounted on 1" x 1" FR4 board

b. See solder profile (<u>www.vishay.com/doc?73257</u>). The PowerPAK 1212-8SH is a leadless package within the PowerPAK 1212-8 package family. The end of the lead terminal is exposed copper (not plated) as a result of the singulation process in manufacturing. A solder fillet at the exposed copper tip cannot be guaranteed and is not required to ensure adequate bottom side solder interconnection

c. Rework conditions: manual soldering with a soldering iron is not recommended for leadless components

S18-0685-Rev. A, 09-Jul-2018

#### 1 For technical questions, contact: <u>pmostechsupport@vishay.com</u>

THIS DOCUMENT IS SUBJECT TO CHANGE WITHOUT NOTICE. THE PRODUCTS DESCRIBED HEREIN AND THIS DOCUMENT ARE SUBJECT TO SPECIFIC DISCLAIMERS, SET FORTH AT www.vishav.com/doc?91000 www.vishay.com

SiSH108DN

Vishay Siliconix

PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNIT	
Static							
Gate threshold voltage	V <sub>GS(th)</sub>	$V_{DS} = V_{GS}$ , $I_D = 250 \ \mu A$	1	-	2	V	
Gate body leakage	I <sub>GSS</sub>	$V_{DS}$ = 0 V, $V_{GS}$ = ± 16 V	-	-	± 100	nA	
Zero gate voltage drain current		$V_{DS} = 20 V, V_{GS} = 0 V$	-	-	1		
	IDSS	$V_{DS}$ = 20 V, $V_{GS}$ = 0 V, $T_J$ = 55 °C	-	-	5	μΑ	
On-state drain current <sup>a</sup>	I <sub>D(on)</sub>	$V_{DS} \ge 5 \text{ V}, V_{GS} = 10 \text{ V}$	40	-	-	А	
Drain aquiras an atata rasistanas à	Р	$V_{GS} = 10 \text{ V}, \text{ I}_{D} = 22 \text{ A}$	D = 22 A - 0.0041 (		0.0049		
Drain-source on-state resistance <sup>a</sup>	R <sub>DS(on)</sub>	V <sub>GS</sub> = 4.5 V, I <sub>D</sub> = 19.7 A - 0.0050			0.0061	Ω	
Forward transconductance a	g <sub>fs</sub>	$V_{DS} = 15 \text{ V}, \text{ I}_{D} = 22 \text{ A}$	-	88	-	S	
Diode forward voltage <sup>a</sup>	V <sub>SD</sub>	$I_{S} = 3.2 \text{ A}, V_{GS} = 0 \text{ V}$	-	0.75	1.2	V	
Dynamic <sup>b</sup>							
Total gate charge	Qg		-	20	30		
Gate-source charge	Q <sub>gs</sub>	$V_{DS}$ = 10 V, $V_{GS}$ = 4.5 V, $I_{D}$ = 22 A	-	6.3	-	nC	
Gate-drain charge	Q <sub>gd</sub>		-	4.9	-		
Gate resistance	Rg	f = 1 MHz	0.7	1.4	2.1	Ω	
Turn-on delay time	t <sub>d(on)</sub>		-	10	15		
Rise time	t <sub>r</sub>	$V_{DD}$ = 20 V, $R_L$ = 20 $\Omega$	-	10	15		
Turn-off delay time	t <sub>d(off)</sub>	$I_D \cong 1 \text{ A}, V_{GEN} = 10 \text{ V}, R_g = 6 \Omega$	-	60	130	ns	
Fall time	t <sub>f</sub>		-	10	15		
Source-drain reverse recovery time	t <sub>rr</sub>		-	30	60		
Reverse recovery charge	Q <sub>rr</sub>	I <sub>F</sub> = 3.2 A, di/dt = 100 A/μs	-	20	36	nC	

Notes

a. Pulse test; pulse width  $\leq$  300 µs, duty cycle  $\leq$  2 %

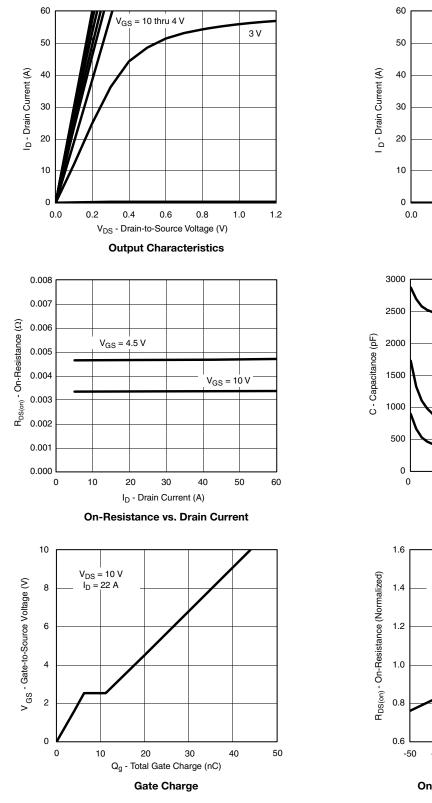
b. Guaranteed by design, not subject to production testing

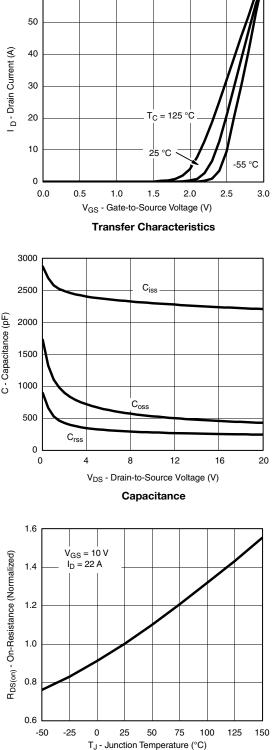
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

2



### TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



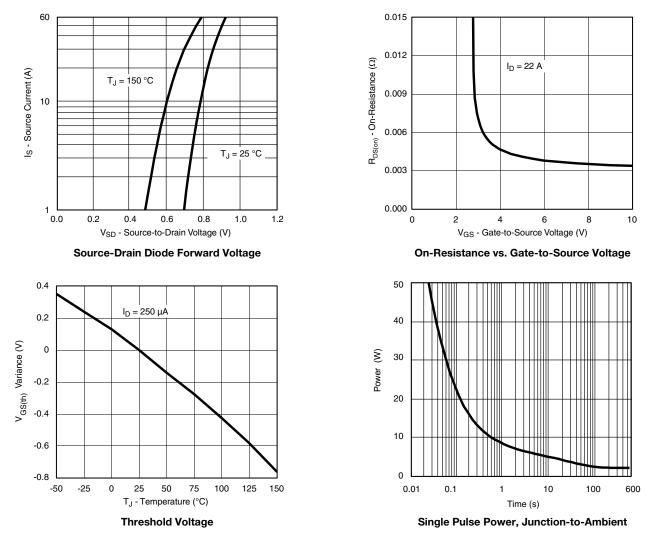


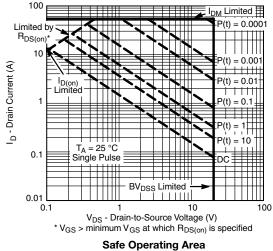
**On-Resistance vs. Junction Temperature** 

Document Number: 79330



### TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

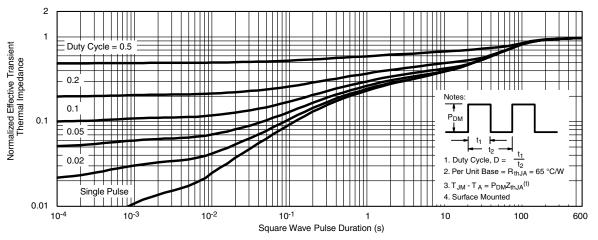




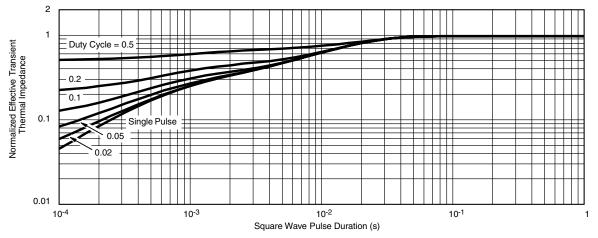
4



#### TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



Normalized Thermal Transient Impedance, Junction-to-Ambient

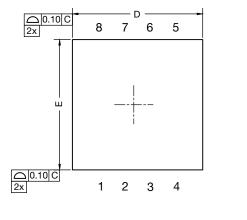


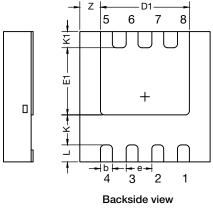
Normalized Thermal Transient Impedance, Junction-to-Case

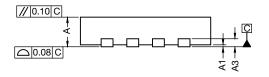
Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package / tape drawings, part marking, and reliability data, see <u>www.vishay.com/ppg?79330</u>.



# PowerPAK<sup>®</sup> 1212-SWLH







DIM.	MILLIMETERS			INCHES				
	MIN.	NOM.	MAX.	MIN.	NOM.	MAX.		
А	0.82	0.90	0.98	0.032	0.035	0.038		
A1	0	-	0.05	0	-	0.002		
A3	0.20 ref.			0.008 ref.				
b		0.30 BSC			0.012 BSC			
D	3.30 BSC			0.130 BSC				
D1	2.15	2.25	2.35	0.084	0.088	0.092		
E		3.30 BSC			0.130 BSC			
E1	1.60	1.70	1.80	0.063	0.067	0.071		
е	0.65 BSC				0.026 BSC			
К		0.76 typ.			0.030 typ.			
K1	0.41 typ.			0.016 typ.				
L	0.43 BSC		0.017 BSC					
Z		0.525 typ.		0.021 typ.				



Vishay

## Disclaimer

ALL PRODUCT, PRODUCT SPECIFICATIONS AND DATA ARE SUBJECT TO CHANGE WITHOUT NOTICE TO IMPROVE RELIABILITY, FUNCTION OR DESIGN OR OTHERWISE.

Vishay Intertechnology, Inc., its affiliates, agents, and employees, and all persons acting on its or their behalf (collectively, "Vishay"), disclaim any and all liability for any errors, inaccuracies or incompleteness contained in any datasheet or in any other disclosure relating to any product.

Vishay makes no warranty, representation or guarantee regarding the suitability of the products for any particular purpose or the continuing production of any product. To the maximum extent permitted by applicable law, Vishay disclaims (i) any and all liability arising out of the application or use of any product, (ii) any and all liability, including without limitation special, consequential or incidental damages, and (iii) any and all implied warranties, including warranties of fitness for particular purpose, non-infringement and merchantability.

Statements regarding the suitability of products for certain types of applications are based on Vishay's knowledge of typical requirements that are often placed on Vishay products in generic applications. Such statements are not binding statements about the suitability of products for a particular application. It is the customer's responsibility to validate that a particular product with the properties described in the product specification is suitable for use in a particular application. Parameters provided in datasheets and / or specifications may vary in different applications and performance may vary over time. All operating parameters, including typical parameters, must be validated for each customer application by the customer's technical experts. Product specifications do not expand or otherwise modify Vishay's terms and conditions of purchase, including but not limited to the warranty expressed therein.

Except as expressly indicated in writing, Vishay products are not designed for use in medical, life-saving, or life-sustaining applications or for any other application in which the failure of the Vishay product could result in personal injury or death. Customers using or selling Vishay products not expressly indicated for use in such applications do so at their own risk. Please contact authorized Vishay personnel to obtain written terms and conditions regarding products designed for such applications.

No license, express or implied, by estoppel or otherwise, to any intellectual property rights is granted by this document or by any conduct of Vishay. Product names and markings noted herein may be trademarks of their respective owners.

# **Mouser Electronics**

Authorized Distributor

Click to View Pricing, Inventory, Delivery & Lifecycle Information:

Vishay: SISH108DN-T1-GE3